

1.Description

The SOP-8 has been modified through a customized leadframe for enhanced thermal characteristics and multiple-die capability making it ideal in a variety of power applications. With these improvements, multiple devices can be used in an application with dramatically reduced board space. The package is designed for vapor phase, infra red, or wave soldering techniques. Power dissipation of greater than 0.8W is possible in a typical PCB mount application.

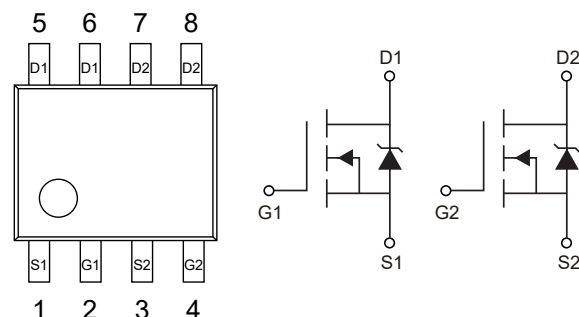
2.Features

- $V_{DS(V)}=55V$, $I_D=4.7A$
- $R_{DS(ON)}<40m\Omega(V_{GS}=10)$
- $R_{DS(ON)}<55m\Omega(V_{GS}=4.5V)$
- Generation V Technolog
- Ultra Low On-Resistance
- Dual N-Channel Mosfet
- Surface Mount
- Dynamic dv/dt Rating
- Fast Switching

3.Pinning information

Pin	Symbol	Description
2,4	G1,G2	GATE
1,3	S1,S2	SOURCE
5,6,7,8	D1,D2	DRAIN

SOP-8



4.Absolute Maximum Ratings $T_A=25^{\circ}C$ unless otherwise noted

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	55	V
Continuous Drain Current, $V_{GS}=10V$	I_D	4.7	A
Continuous Drain Current, $V_{GS}=10V$		3.8	A
Pulsed Drain Current ①	I_{DM}	38	A
Power Dissipation	P_D	2	W
Power Dissipation		1.3	W
Linear Derating Factor		0.016	W/ $^{\circ}C$
Gate-to-Source Voltage	V_{GS}	± 20	V
Gate-to-Source Voltage Single Pulse $t_p<10\mu s$	V_{GSM}	30	V



Single Pulse Avalanche Energy ②	E_{AS}	72	mJ
Peak Diode Recovery dv/dt ③	dv/dt	5	V/ns
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

5.Thermal Resistance Rating

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ⑤	$R_{\theta JA}$		62.5	°C/W



6. Electrical Characteristics $T_J=25^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=250\mu\text{A}$, $V_{GS}=0\text{V}$	55			V
Breakdown Voltage Temp. Coefficient	$\Delta V_{(BR)DSS}/T_J$	$I_D=1\text{mA}$, Reference to 25°C		0.059		V/ $^{\circ}\text{C}$
Static Drain-to-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10\text{V}$, $I_D=4.7\text{A}$ ④		0.028	0.04	Ω
		$V_{GS}=4.5\text{V}$, $I_D=3.8\text{A}$ ④		0.03	0.055	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	1			V
Forward Transconductance	g_{FS}	$V_{DS}=10\text{V}$, $I_D=4.5\text{A}$	7.9			S
Drain-to-Source Leakage Current	I_{DSS}	$V_{DS}=55\text{V}$, $V_{GS}=0\text{V}$			2	μA
		$V_{DS}=55\text{V}$, $V_{GS}=0\text{V}$, $T_J=55^{\circ}\text{C}$			25	
Gate-to-Source Forward Leakage	I_{GSS}	$V_{GS}=-20\text{V}$			-100	nA
Gate-to-Source Reverse Leakage		$V_{GS}=20\text{V}$			100	
Total Gate Charge	Q_g	$I_D=4.5\text{A}$		24	36	nC
Gate-to-Source Charge	Q_{gs}	$V_{DS}=44\text{V}$, $V_{GS}=10\text{V}$		2.3	3.4	
Gate-to-Drain ("Miller") Charge	Q_{gd}	See Fig. 10 ④		7	10	
Turn-On Delay Time	$t_{D(on)}$	$V_{DD}=28\text{V}$		8.3	12	ns
Rise Time	t_r	$I_D=1\text{A}$		3.2	4.8	ns
Turn-Off Delay Time	$t_{D(off)}$	$R_G=6\Omega$		32	48	ns
Fall Time	t_f	$R_D=16\Omega$ ④		13	20	ns
Input Capacitance	C_{iss}	$V_{GS}=0\text{V}$		740		pF
Output Capacitance	C_{oss}	$V_{DS}=-25\text{V}$		190		pF
Reverse Transfer Capacitance	C_{rss}	$f=1.0\text{MHz}$, See Fig. 9		71		pF



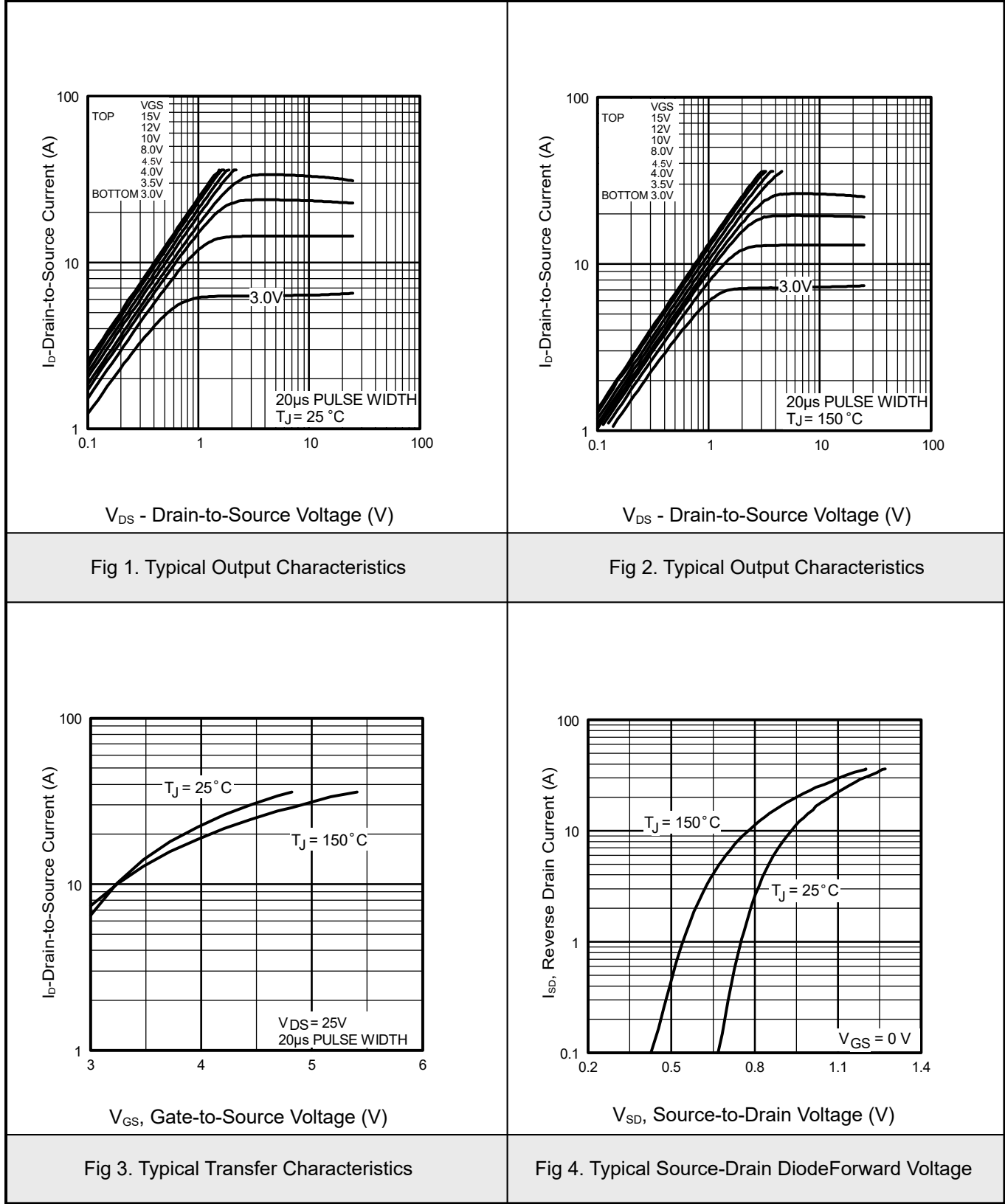
Source-Drain Ratings and Characteristics						
Continuous Source Current (Body Diode)	I_S	MOSFET symbol showing the integral reverse p-n junction diode.			-2	A
Pulsed Source Current (Body Diode) ①	I_{SM}				38	
Diode Forward Voltage	V_{SD}		$T_J=25^{\circ}\text{C}, I_S=1.7\text{A}, V_{GS}=0\text{V}$ ③		1.2	V
Reverse Recovery Time	t_{rr}	$T_J=25^{\circ}\text{C}, I_F=1.7\text{A}$		60	90	ns
Reverse Recovery Charge	Q_{rr}	$di/dt=100\text{A}/\mu\text{s}$ ③		120	170	nC

Notes:

- ① Repetitive rating; pulse width limited by max.junction temperature.(See fig.11)
- ② Starting $T_J=25^{\circ}\text{C}$, $L=6.5\text{mH}$, $R_G=25\Omega$, $I_{AS}=4.7\text{A}$.(See Figure 8)
- ③ $I_{SD}\leq 4.7\text{A}$, $di/dt\leq 220\text{A}/\mu\text{s}$, $V_{DD}\leq V_{(BR)DSS}$, $T_J\leq 150^{\circ}\text{C}$.
- ④ Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.
- ⑤ When mounted on 1 inch square copper board, $t<10$ sec.

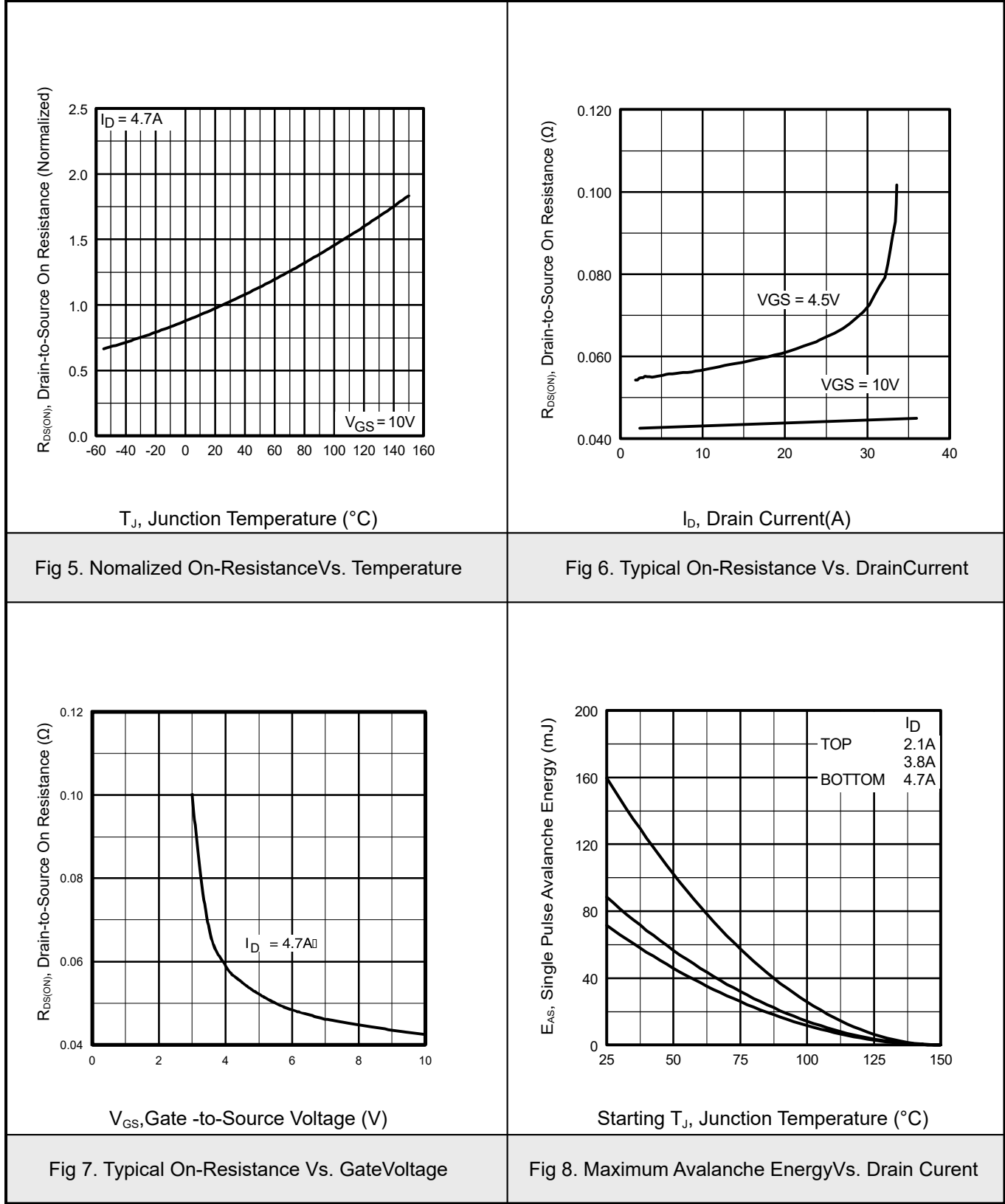


7.1Typical Characterisitics



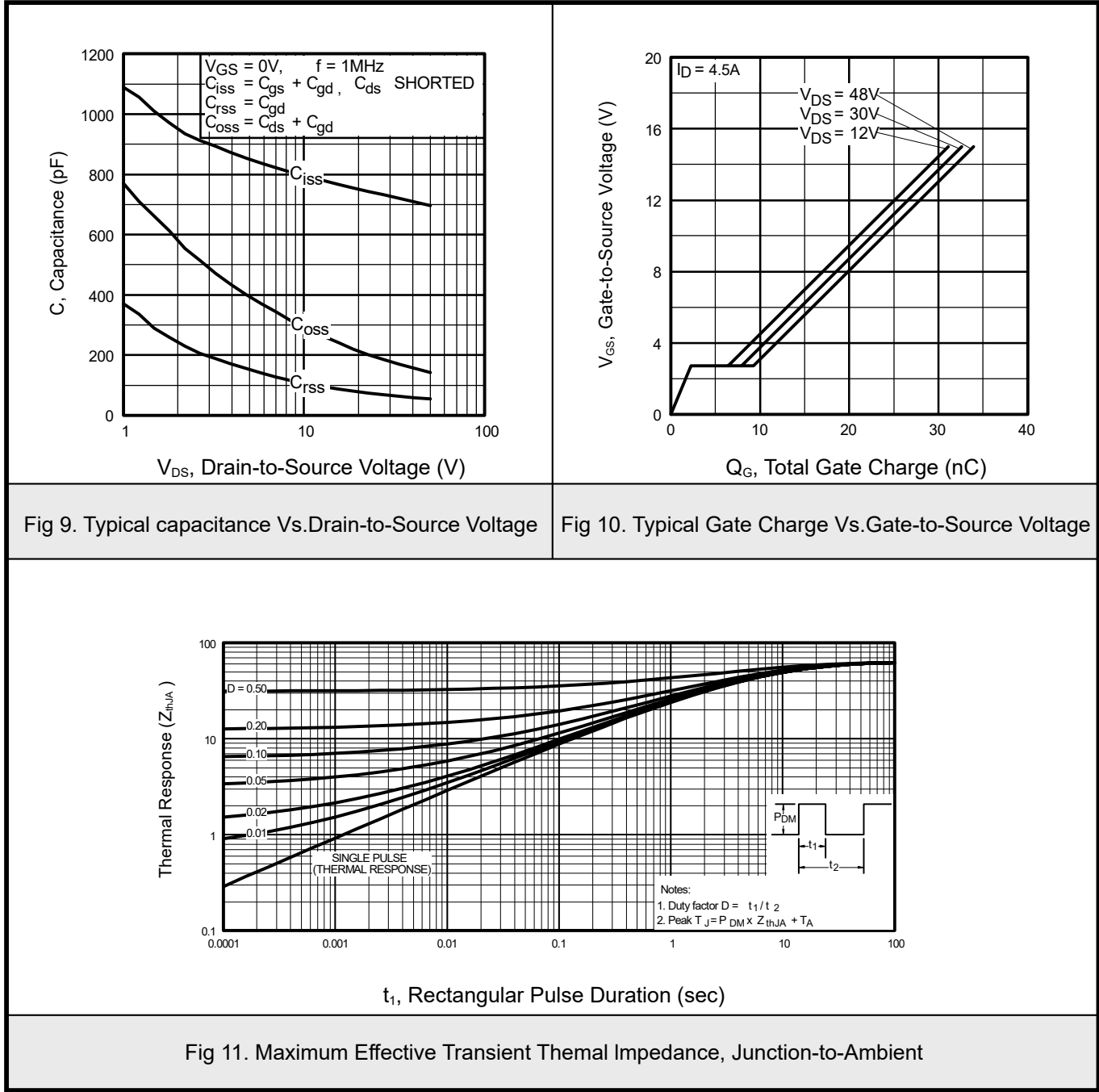


7.2Typical Characteristics



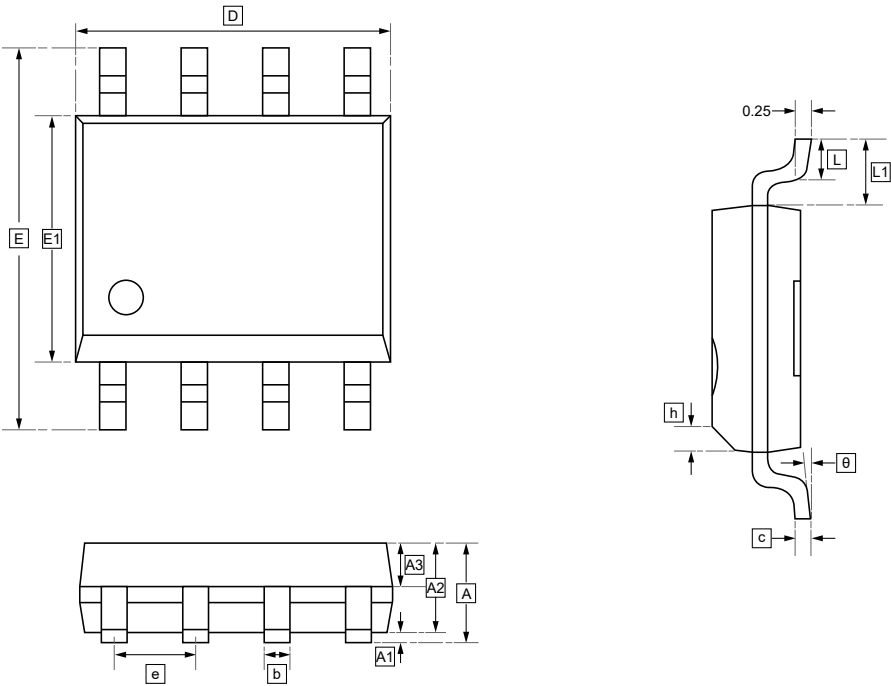


7.3Typical Characteristics





8.SOP-8 Package Outline Dimensions



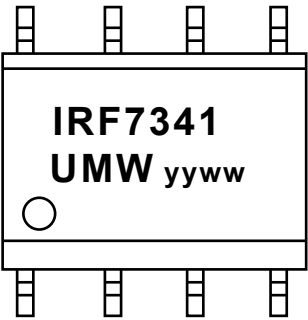
DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	A3	b	c	D	E	E1	e	h	L
Min	-	0.05	1.30	0.60	0.39	0.20	4.80	5.80	3.80	1.24	0.30	0.50
Max	1.75	0.20	1.50	0.70	0.47	0.24	5.00	6.20	4.00	1.30	0.50	0.80

Symbol	L1	θ
Min	1.00	0°
Max	1.10	8°



9.Ordering information



yy: Year Code
ww: Week Code

Order Code	Package	Base QTY	Delivery Mode
UMW IRF7341TR	SOP-8	3000	Tape and reel



10.Disclaimer

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